



IFW 1732

PATENT
10/502,116
2710/72740

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Suzuki Yasuhiro
Serial No. : 10/502,116
Filing Date : July 21, 2004
For : PROCESS FOR PRODUCING MOLDED ARTICLE OF
RECLAIMED THERMOPLASTIC RESIN
Group A.U. : 1732
Conf. No. : 2115
Examiner : Suzanne E. McDowell

I hereby certify that this paper is being deposited this date with the
U.S. Postal Service in first class mail addressed to: Commissioner for
Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Donald S. Dowden

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Reg. No. 20,701

Date
November 17, 2006

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November 17, 2006

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE

SIR:

This is in response to a notice of non-compliant amendment mailed November 9, 2006, advising that claims 1-11 were missing from the amendment filed October 30, 2006, which was in response to a non-final Office action dated June 29, 2006. Those claims were canceled, as indicated on page 6 of that amendment. Since box 4 of the notice is checked, we are submitting herewith, beginning of page 2 of this paper, only the corrected Claims section of the amendment, in compliance with section 2 of the notice.